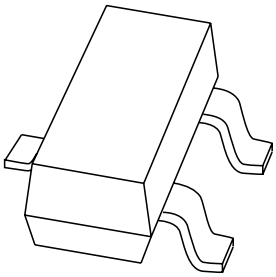
DATA SHEET



BCV26; BCV46
PNP Darlington transistors

Product specification
Supersedes data of 1999 Apr 08

2004 Jan 13

Philips
Semiconductors

PHILIPS

PNP Darlington transistors BCV26; BCV46

FEATURES

- High current (max. 500 mA)
- Low voltage (max. 60 V)
- Very high DC current gain (min. 10000).

APPLICATIONS

- Where very high amplification is required.

DESCRIPTION

PNP Darlington transistor in a SOT23 plastic package.
NPN complements: BCV27 and BCV47.

MARKING

TYPE NUMBER	MARKING CODE(1)
BCV26	FD*
BCV46	FE*

Note

1. * = p : Made in Hong Kong.
   * = t : Made in Malaysia.
   * = W : Made in China.

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector

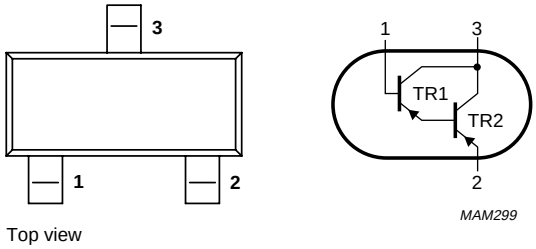


Fig.1 Simplified outline (SOT23) and symbol.

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
BCV26	–	plastic surface mounted package; 3 leads	SOT23
BCV46			

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter			
	BCV26		–	–40	V
	BCV46		–	–80	V
V_{CES}	collector-emitter voltage	V_{BE} = 0			
	BCV26		–	–30	V
	BCV46		–	–60	V
V_{EBO}	emitter-base voltage	open collector	–	–10	V
I_C	collector current (DC)		–	–500	mA
I_{CM}	peak collector current		–	–800	mA
I_B	base current (DC)		–	–100	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C; note 1	–	250	mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C
T_{amb}	operating ambient temperature		–65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th(j-a)}$	thermal resistance from junction to ambient	note 1	500	K/W

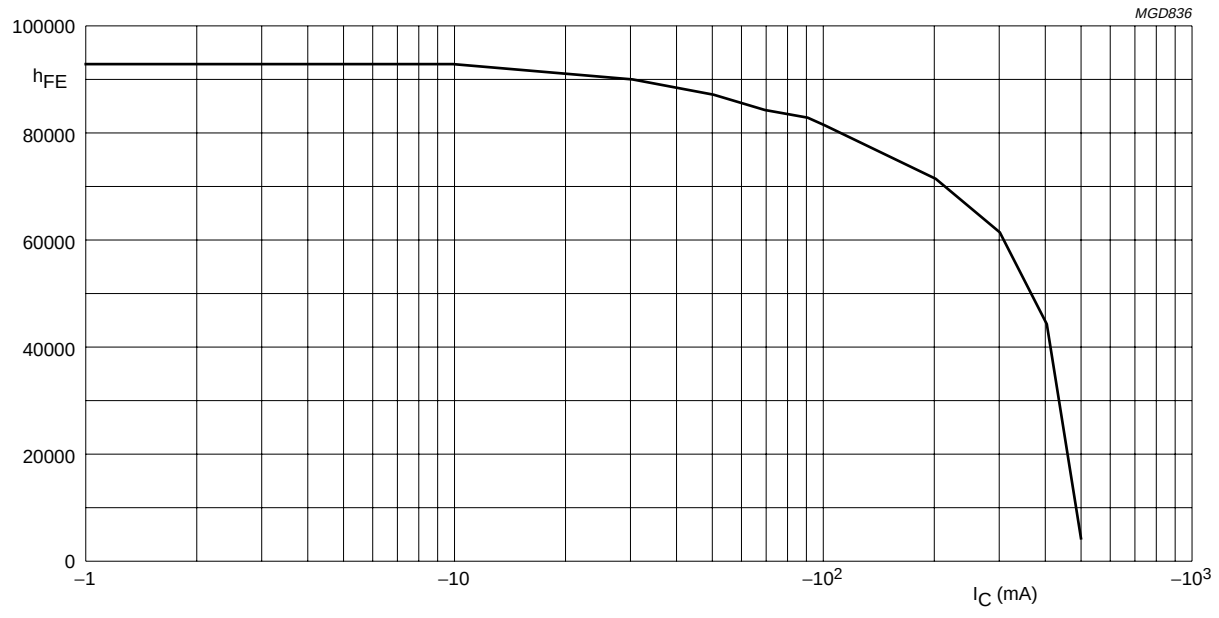
Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current					
	BCV26	I_E = 0; V_{CB} = –30 V	–	–	–100	nA
	BCV46	I_E = 0; V_{CB} = –60 V	–	–	–100	nA
I_{EBO}	emitter cut-off current	I_C = 0; V_{EB} = –10 V	–	–	–100	nA
h_{FE}	DC current gain	I_C = –1 mA; V_{CE} = –5 V; (see Fig.2)				
	BCV26		4000	–	–	
	BCV46		2000	–	–	
	DC current gain	I_C = –10 mA; V_{CE} = –5 V; (see Fig.2)				
	BCV26		10000	–	–	
	BCV46		4000	–	–	
	DC current gain	I_C = –100 mA; V_{CE} = –5 V; (see Fig.2)				
	BCV26		20000	–	–	
	BCV46		10000	–	–	
V_{CEsat}	collector-emitter saturation voltage	I_C = –100 mA; I_B = –0.1 mA	–	–	–1	V
V_{BEsat}	base-emitter saturation voltage	I_C = –100 mA; I_B = –0.1 mA	–	–	–1.5	V
V_{BEon}	base-emitter on-state voltage	I_C = –10 mA; V_{CE} = –5 V	–	–	–1.4	V
f_T	transition frequency	I_C = –30 mA; V_{CE} = –5 V; f = 100 MHz	–	220	–	MHz

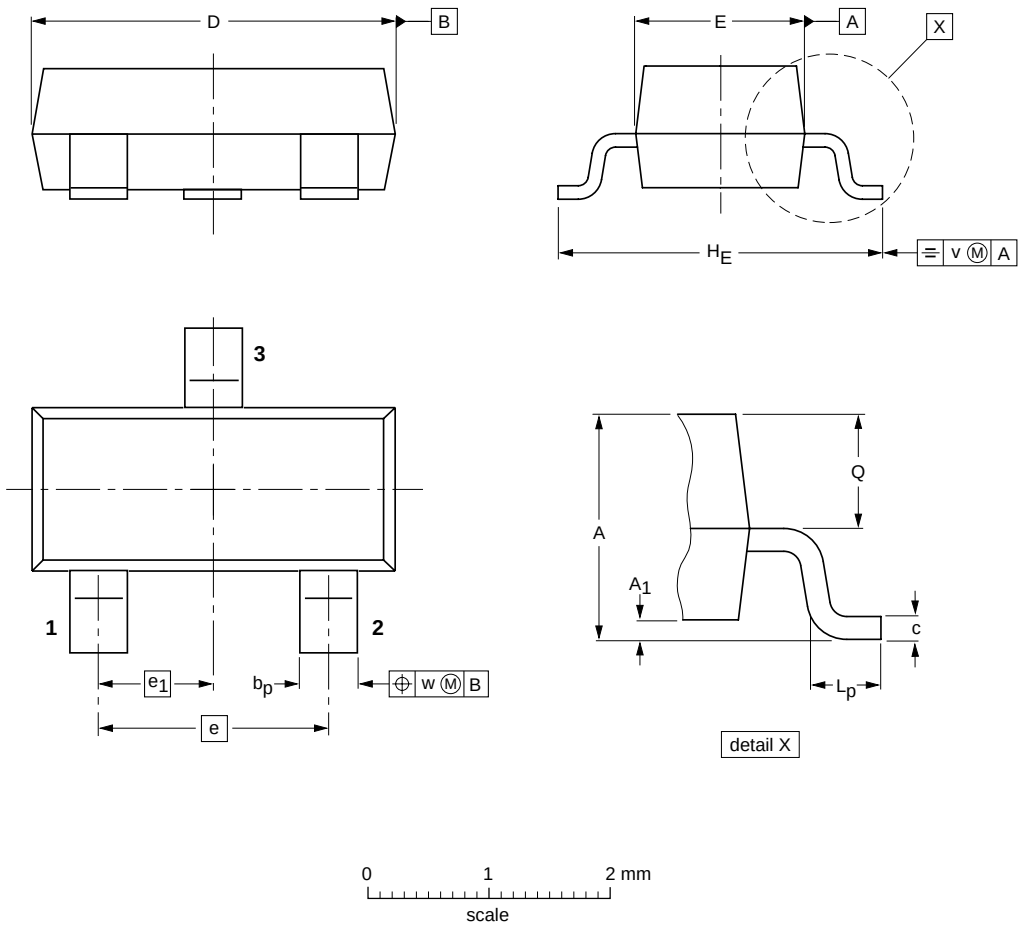


V_{CE} = –2 V.

Fig.2 DC current gain; typical values.

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads **SOT23**



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1 max.	b_p	c	D	E	e	e_1	H_E	L_p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT23		TO-236AB				~~97-02-28~~ 99-09-13

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS(1)	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

1. Please consult the most recently issued data sheet before initiating or completing a design.
2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

DISCLAIMERS

Life support applications — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes in the products - including circuits, standard cells, and/or software - described or contained herein in order to improve design and/or performance. When the product is in full production (status ‘Production’), relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors – a worldwide company

Contact information

For additional information please visit **http://www.semiconductors.philips.com**. Fax: **+31 40 27 24825**
For sales offices addresses send e-mail to: **sales.addresses@www.semiconductors.philips.com**.

Printed in The Netherlands R75/05/pp7 Date of release: 2004 Jan 13 Document order number: 9397 750 12401

Let's make things better.

Philips
Semiconductors

PHILIPS